

DATA SHEET

THICK FILM CHIP RESISTORS **Automotive Precision grade**

AE series 0.1%, 0.5%, 1%, TC 25/50

Sizes 0402/0603/0805/1206

RoHS compliant & Halogen Free



YAGEO



SCOPE

YAGEO

This specification describes AE0402 to AE1206 ultra precision chip resistors with lead-free terminations made by thick film process.

APPLICATIONS

- All general purpose applications
- Car electronics
- Industrial applications

FEATURES

- AEC-Q200 qualified
- Halogen Free Epoxy
- RoHS compliant
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Moisture sensitivity level: MSL I

ORDERING INFORMATION - GLOBAL PART NUMBER & 12NC

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code GLOBAL PART NUMBER (PREFERRED)

AE XXXX X X X XX XXXX L

(1) (2) (3) (4) (5) (6) (7)

(I) SIZE

0402 / 0603 / 0805 / 1206

(2) TOLERANCE

 $B = \pm 0.1\%$

 $D = \pm 0.5\%$

 $F = \pm 1\%$

(3) PACKAGING TYPE

R = Paper/PE taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

 $E = \pm 50 \text{ ppm/}^{\circ}\text{C}$

(5) TAPING REEL

07 = 7 inch dia, Reel

13 = 13 inch dia, Reel

(6) RESISTANCE VALUE

There are $2\sim4$ digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

(7) DEFAULT CODE

Letter L is system default code for order only (Note)

Resistance rule of global part number

Resistance code rule	Example
XXRX	IOR = IO Ω
(10 to 97.6 Ω)	97R6 = 97.6 Ω
XXXR (100 to 976 Ω)	100R = 100 Ω
XKXX	IK = 1,000 Ω
(Ι to 9.76 K Ω)	9K $76 = 9760 Ω$
XMXX (Ι ΜΩ)	$IM = 1,000,000 \Omega$

ORDERING EXAMPLE

The ordering code of a AE0603 chip resistor, TC 25 value 56Ω with $\pm 0.5\%$ tolerance, supplied in 7-inch tape reel is: AE0603DR-0756RL.

NOTE

- All our R-Chip products meet RoHS compliant and Halogen Free. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- 2. On customized label, "LFP" or specific symbol can be printed





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<u>MARKING</u>

AE0402



No marking

AE0603 /AE0805 / AE1206



E-24 series: 3 digits, ±5%

First two digits for significant figure and 3rd digit for number of zeros

AE0603



E-24 series: 3 digits, ±1% & ±0.5% One short bar under marking letter



E-96 series: 3 digits, ±1% & ±0.5%

First two digits for E-96 marking rule and 3rd letter for number of zeros

AE1206



Either resistance in E-24 or E-96: 4 digits

First three digits for significant figure and 4th digit for number of zeros

For further marking information, please see special data sheet "Chip resistors marking".

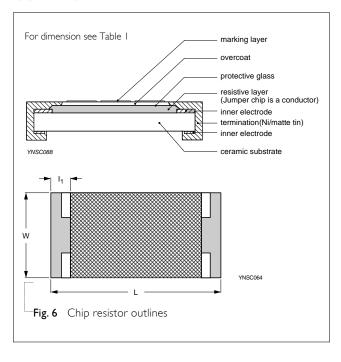
CONSTRUCTION

The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive layer. The resistive layer is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with a protective coat and printed with the resistance value. Finally, the two external terminations (matte tin) are added. See fig. 6.

Table I For outlines see fig. 6

TYPE	L (mm)	W (mm)	H (mm)	I _I (mm)	l ₂ (mm)
AE0402	1.00 ±0.05	0.50 ±0.05	0.32 ±0.05	0.16 +0.14/	0.29 ±0.10
AE0603	1.60 ±0.10	0.80 ±0.10	0.45 ±0.10	0.20 +0.20 -0.10	0.45 ±0.15
AE0805	2.00 ±0.10	1.25 ±0.10	0.50 ±0.10	0.25 +0.25 -0.15	0.50 +0.10/
AE1206	3.10 ±0.20	1.60 ±0.10	0.60 ±0.10	0.35 ±0.20	0.50 ±0.20

OUTLINES



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ELECTRICAL CHARACTERISTICS

Table 2

TYPE	RESISTANCE RANGE (E24/E96)	OPERATING TEMPERATURE RANGE	POWER RATING	MAXIMUM WORKING VOLTAGE	DIELECTRIC WITHSTAN D VOLTAGE	MAXIMUM OVERLOAD VOLTAGE	TEMPERATURE COEFFICIENT OF RESISTANCE
AE0402	100Ω to ΙΜΩ	_	1/8 W	75 V	100 V	100 V	- : Hot : ±25ppm/°C
AE0603	100Ω to $1M\Omega$	_55 °C to +155 °C=	1/5 W	100 V	150 V	150 V	Cold: -50~+25ppm/°C
AE0805	100Ω to $1M\Omega$		1/4 W	150 V	300 V	300 V	F + F0 /9C
AE1206	100K Ω to 1M Ω		1/3 W	200 V	500 V	400 V	E : ±50ppm/°C

SERIES

0402 to 1206

NOTE

The maximum working voltage that may be continuously applied to the resistor element, see "IEC publication 60115-8"

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting"

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	AE0402	AE0603	AE0805	AE1206
Paper/PE taping reel (R)	7" (178 mm)	10,000	5,000	5,000	5,000
raper/r L taping reer (it)	13" (330 mm)	50,000	20,000	20,000	20,000

NOTE

1. For Paper/PE tape and reel specification/dimensions, please see the special data sheet "Chip resistors packing"

FUNCTIONAL DESCRIPTION

POWER RATING

Each type rated power at 70°C:

AE0402=1/8W

AE0603=1/5W

AE0805=1/4W

AEI206=I/3W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

 $V=V(P \times R)$

or max. working voltage whichever is less

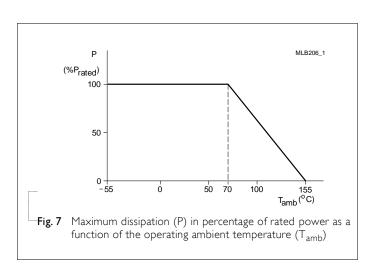
Where

V=Continuous rated DC or

AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value (Ω)





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TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST METHOD	PROCEDURE	REQUIREMENTS
AEC-Q200 Test 3 MIL-STD-202 Method 108	1,000 hours at T_A = 155 °C, unpowered	±(0.5%+0.05Ω)
AEC-Q200 Test 6 MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	±(0.5%+0.05Ω)
	Parts mounted on test-boards, without condensation on parts	
AEC-Q200 Test 7 MIL-STD-202 Method 103	1,000 hours; 85 °C / 85% RH 10% of operating power	±(1.0%+0.05Ω)
	rieasurement at 24±4 nours after test conclusion.	
AEC-Q200 Test 8 MIL-STD-202 Method 108	1,000 hours at 125 °C, derated voltage applied for 1.5 hours on, 0.5 hour off, still-air required	±(1.0%+0.05Ω)
AEC-Q200 Test 15	Condition B, no pre-heat of samples	±(0.2%+0.05Ω)
MIL-STD-202 Method 210	Lead-free solder, 260±5 °C, 10±1 seconds immersion time	No visible damage
	Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	
AEC-Q200 Test 16	-55/+125 °C	±(0.5%+0.05Ω)
MIL-STD-202 Method 107	Number of cycles is 300. Devices mounted	
	Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	
AEC-Q200 Test 17	Human Body Model,	±(3.0%+0.05Ω)
AEC-Q200-002	I pos. + I neg. discharges	
	0402/0603: TKV	
	AEC-Q200 Test 3 MIL-STD-202 Method 108 AEC-Q200 Test 6 MIL-STD-202 Method 106 AEC-Q200 Test 7 MIL-STD-202 Method 103 AEC-Q200 Test 8 MIL-STD-202 Method 108 AEC-Q200 Test 15 MIL-STD-202 Method 210 AEC-Q200 Test 16 MIL-STD-202 Method 107	AEC-Q200 Test 3 MIL-STD-202 Method 108 AEC-Q200 Test 6 MIL-STD-202 Method 106 AEC-Q200 Test 6 MIL-STD-202 Method 106 AEC-Q200 Test 7 MIL-STD-202 Method 103 AEC-Q200 Test 8 MIL-STD-202 Method 103 AEC-Q200 Test 8 MIL-STD-202 Method 108 AEC-Q200 Test 15 AEC-Q200 Test 15 MIL-STD-202 Method 210 AEC-Q200 Test 16 MIL-STD-202 Method 210 AEC-Q200 Test 16 MIL-STD-202 Method 107 AEC-Q200 Test 17 Human Body Model,



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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability			
- Wetting	AEC-Q200 Test 18	Electrical Test not required Magnification 50X	Well tinned (≥95% covered)
	J-STD-002	SMD conditions:	No visible damage
		(a) Method B, aging 4 hours at 155 °C dry heat, dipping at 235±3 °C for 5±0.5 seconds.	
		(b) Method B, steam aging 8 hours, dipping at 215 ± 3 °C for 5 ± 0.5 seconds.	
		(c) Method D, steam aging 8 hours, dipping at 260±3 °C for 30±0.5 seconds.	
Board Flex	AEC-Q200 Test 21 AEC-Q200-005	Chips mounted on a 90mm glass epoxy resin PCB (FR4)	±(1.0%+0.05Ω)
	7.120 2200 003	Bending for 0402: 5 mm 0603/0805: 3 mm 1206 and above: 2 mm	
		Holding time: minimum 60 seconds	
Temperature	MIL-STD-202 Method 304	At +25/–55 °C and +25/+125 °C	Refer to table 2
Coefficient of Resistance (T.C.R.)		Formula:	
Resistance (T.C.R.)		T.C.R= $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where t ₁ =+25 °C or specified room temperature	
		t_2 =-55 °C or +125 °C test temperature	
		R ₁ =resistance at reference temperature in ohms	
		R ₂ =resistance at test temperature in ohms	
Short Time Overload	IEC60115-1 4.13	2.5 times of rated voltage or maximum overload voltage whichever is less for 5 sec at room temperature	±(0.5%+0.05Ω)
FOS	ASTM-B-809-95	Sulfur (saturated vapor) 500 hours, 60±2°C, unpowered	±(1.0%+0.05Ω)



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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version I	Jan. 20, 2025		- Add size 0402, 0603, 0805
Version 0	Jul. 18, 2023		- New datasheet for Automotive thick film ultra precision chip resistors sizes of 0402/0603/0805/1206, 0.1%, 0.5%, 1%, TC25



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